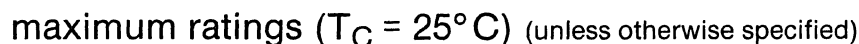




8 AMPERES
500, 450 VOLTS
R_{DS(ON)} = 0.85 Ω

This design has been optimized to give superior performance in most switching applications including: switching power supplies, inverters, converters and solenoid/relay drivers. Also, the extended safe operating area with good linear transfer characteristics makes it well suited for many linear applications such as audio amplifiers and servo motors.

- Polysilicon gate — Improved stability and reliability
- No secondary breakdown — Excellent ruggedness
- Ultra-fast switching — Independent of temperature
- Voltage controlled — High transconductance
- Low input capacitance — Reduced drive requirement
- Excellent thermal stability — Ease of paralleling



thermal characteristics

(1) Repetitive Rating: Pulse width limited by max. junction temperature.

electrical characteristics ($T_C = 25^\circ\text{C}$) (unless otherwise specified)

CHARACTERISTIC	SYMBOL	MIN	TYP	MAX	UNIT
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off characteristics

Drain-Source Breakdown Voltage ($V_{GS} = 0V$, $I_D = 250\mu A$)	IRF840/D84ER2 IRF841/D84ER1	BV_{DSS}	500 450	— —	Volts
Zero Gate Voltage Drain Current ($V_{DS} = \text{Max Rating}$, $V_{GS} = 0V$, $T_C = 25^\circ\text{C}$) ($V_{DS} = \text{Max Rating}$, $\times 0.8$, $V_{GS} = 0V$, $T_C = 125^\circ\text{C}$)		I_{DSS}	— —	— 250 1000	μA
Gate-Source Leakage Current ($V_{GS} = \pm 20V$)		I_{GSS}	—	± 500	nA

on characteristics*

Gate Threshold Voltage ($V_{DS} = V_{GS}$, $I_D = 250\mu A$)	$T_C = 25^\circ\text{C}$	$V_{GS(TH)}$	2.0	—	4.0	Volts
On-State Drain Current ($V_{GS} = 10V$, $V_{DS} = 10V$)		$I_{D(ON)}$	8	—	—	A
Static Drain-Source On-State Resistance ($V_{GS} = 10V$, $I_D = 4A$)		$R_{DS(ON)}$	—	0.75	0.85	Ohms
Forward Transconductance ($V_{DS} = 10V$, $I_D = 4A$)		g_{fs}	2.8	3.5	—	mhos

dynamic characteristics

Input Capacitance	$V_{GS} = 0V$	C_{iss}	—	1400	1600	pF
Output Capacitance	$V_{DS} = 25V$	C_{oss}	—	190	350	pF
Reverse Transfer Capacitance	$f = 1\text{ MHz}$	C_{rss}	—	28	150	pF

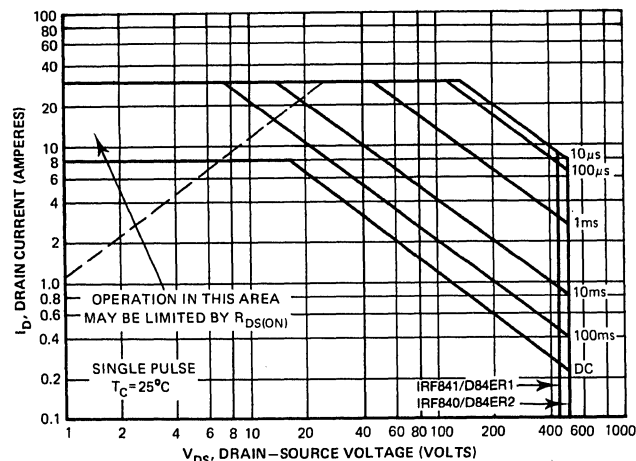
switching characteristics*

Turn-on Delay Time	$V_{DS} = 225V$	$t_{d(on)}$	—	20	—	ns
Rise Time	$I_D = 4A$, $V_{GS} = 15V$	t_r	—	20	—	ns
Turn-off Delay Time	$R_{GEN} = 50\Omega$, $R_{GS} = 12.5\Omega$	$t_{d(off)}$	—	60	—	ns
Fall Time	($R_{GS} \text{ (EQUIV.)} = 10\Omega$)	t_f	—	30	—	ns

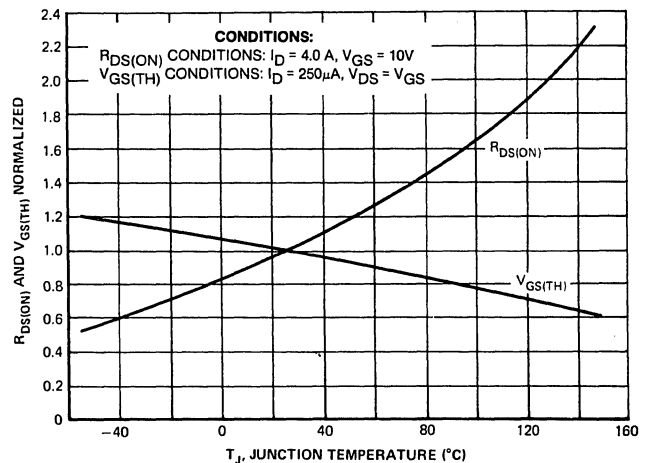
source-drain diode ratings and characteristics*

Continuous Source Current	I_S	—	—	8	A
Pulsed Source Current	I_{SM}	—	—	32	A
Diode Forward Voltage ($T_C = 25^\circ\text{C}$, $V_{GS} = 0V$, $I_S = 8A$)	V_{SD}	—	0.9	2.0	Volts
Reverse Recovery Time ($I_S = 8A$, $dI_S/dt = 100A/\mu\text{sec}$, $T_C = 125^\circ\text{C}$)	t_{rr} Q_{RR}	—	520 6.4	—	ns μC

*Pulse Test: Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$



MAXIMUM SAFE OPERATING AREA



TYPICAL NORMALIZED $R_{DS(ON)}$ AND $V_{GS(TH)}$ VS. TEMP.